146281-2 - ACTIVE

AMPMODU | AMPMODU Headers

TE Internal #: 146281-2 PCB Mount Header, Vertical, Board-to-Board, 2 Position, .1 in [2.54 mm] Centerline, Breakaway, Gold, Through Hole - Solder, Signal, AMPMODU Headers

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 2

Number of Rows: 1

Features

Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Breakaway

Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Vertical
Number of Positions	2
Number of Rows	1
Board-to-Board Configuration	Parallel
Body Features	
Primary Product Color	Black
Contact Features	
Mating Square Post Dimension	.64 mm[.025 in]
	10 – 20 µin
Contact Shape & Form	Square
Contact Underplating Material	Nickel

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Tin-Lead	
Copper Alloy	
Gold	
.762 μm[30 μin]	
Pin	
3 A	
.64 mm[.025 in]	
3.05 mm[.12 in]	
Through Hole - Solder	
Without	
Without	
Without	
Board Mount	
2.54 mm[.1 in]	
LCP (Liquid Crystal Polymer), LCP-GF (Liquid Crystal Polymer)	
1.6 mm[.063 in]	
High	
-65 – 105 °C[-85 – 221 °F]	
Signal	
CSA LR7189, UL E28476	
UL 94V-0	
UL 94V-0	
UL 94V-0 500	

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Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2022 (223) SVHC > Threshold: Pb (13% in Component Part) Aticle Safe Usage Statements Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Low Bromine/Chlorine - Br and Cl < 900 ppm per homogenous material. Also BFR /CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent

chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts



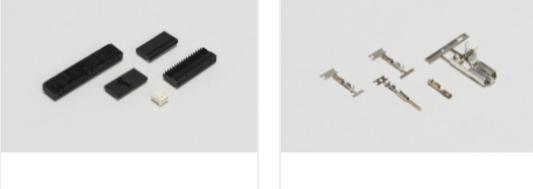
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Also in the Series AMPMODU Headers





Wire-to-Board Connector Assemblies	Wire-to-Board
& Housings(5)	

Wire-to-Board Connector Contacts(66)

Customers Also Bought



PCB Mount Header, Vertical, Board-to-Board, 2 Position, .1 in [2.54 mm] Centerline, Breakaway, Gold, Through Hole - Solder, Signal, AMPMODU Headers



Documents

Product Drawings 02 MODII HDR SRST B/A .100CL

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_146281-2_D.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_146281-2_D.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_146281-2_D.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages AMPMODU Interconnetion System

AMPMODU Interconnetion System

English

Product Specifications Application Specification

English